2-input NAND gate; open drain Rev. 2 — 9 December 2016

Product data sheet

General description 1.

The 74LVC1G38-Q100 provides a 2-input NAND function.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device as translator in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using IOFF. The IOFF circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1) Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant outputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V).
- ± 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Open drain outputs
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)

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3. Ordering information

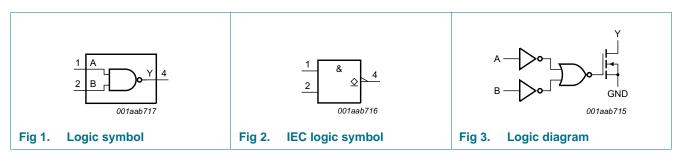
Table 1. Ordering information								
Type number	Package							
	Temperature range	Name	Description	Version				
74LVC1G38GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1				
74LVC1G38GV-Q100	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753				

4. Marking

Type number	Marking code ^[1]
74LVC1G38GW-Q100	YB
74LVC1G38GV-Q100	YB

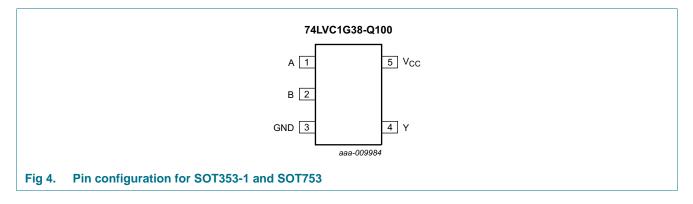
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description						
Symbol	Pin	Description				
A	1	data input				
В	2	data input				
GND	3	ground (0 V)				
Y	4	data output				
V _{CC}	5	supply voltage				

7. Functional description

Table 4. Function table^[1]

Input	Output	
Α	В	Y
L	L	Z
L	Н	Z
н	L	Z
Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF state.

8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			, 0			,	
Symbol	Parameter	Conditions		Min	Max	Unit	
V _{CC}	supply voltage			-0.5	+6.5	V	
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA	
VI	input voltage		<u>[1]</u>	-0.5	+6.5	V	
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA	
Vo	output voltage	Active mode	[1][2]	-0.5	+6.5	V	
		Power-down mode	[1][2]	-0.5	+6.5	V	
I _O	output current	$V_{O} = 0 V$ to V_{CC}		-	±50	mA	
I _{CC}	supply current			-	100	mA	
I _{GND}	ground current			-100	-	mA	
T _{stg}	storage temperature			-65	+150	°C	
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3]	-	300	mW	

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When $V_{CC} = 0 V$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	5.5	V
		Disable mode; V_{CC} = 1.65 V to 5.5 V	0	-	5.5	V
		Power-down mode; $V_{CC} = 0 V$	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and	V _{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
	fall rate	V _{CC} = 2.7 V to 5.5 V	-	-	10	ns/V

Table 6. Recommended operating conditions

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +85 °C <u>[1]</u>					
V _{IH}	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65V_{CC}$	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	0.7V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3V _{CC}	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$	-	-	-	
		I_{O} = 100 μ A; V_{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.3	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.55	V
I _I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	±0.1	±1	μA
I _{OZ}	OFF-state output current		-	±0.1	±2	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±2	μA
I _{CC}	supply current	$V_{I} = 5.5 V \text{ or GND};$ $V_{CC} = 1.65 V \text{ to } 5.5 V; I_{O} = 0 \text{ A}$	-	0.1	4	μA
ΔI_{CC}	additional supply current		-	5	500	μA
CI	input capacitance		-	2.5	-	pF

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = –	40 °C to +125 °C					
	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3V _{CC}	V
V _{OL} LOW-level output volt	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$	-	-	-	
		I_{O} = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.70	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.60	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.80	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.80	V
I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	±1	μA
l _{oz}	OFF-state output current		-	-	±2	μA
OFF	power-off leakage current	$V_1 \text{ or } V_0 = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±2	μA
lcc	supply current	$V_{I} = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to 5.5 V; }I_{O} = 0 \text{ A}$	-	-	4	μA
Δl _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V}$ to 5.5 V; per pin	-	-	500	μA

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 6</u>.

Symbol	Parameter	arameter Conditions		°C to +8	5 °C	–40 °C to +125 °C		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	A, B to Y; see Figure 5						
		V _{CC} = 1.65 V to 1.95 V	1.0	3.0	10.0	1.0	12.5	ns
		V_{CC} = 2.3 V to 2.7 V	0.5	1.8	6.0	0.5	7.5	ns
		V _{CC} = 2.7 V	0.5	2.5	5.0	0.5	6.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0.5	2.3	4.5	0.5	5.7	ns
		$V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	0.5	1.5	3.9	0.5	4.9	ns
C _{PD}	power dissipation capacitance	$V_{CC} = 3.3 \text{ V};$ [3] $V_I = \text{GND to } V_{CC}$	-	6	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $\label{eq:tpd} [2] \quad t_{pd} \text{ is the same as } t_{PZL} \text{ and } t_{PLZ}.$

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\mathsf{P}_{D} = C_{\mathsf{PD}} \times V_{CC}{}^2 \times f_i \times \mathsf{N} + \sum (C_L \times V_{CC}{}^2 \times f_o)$ where:

f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

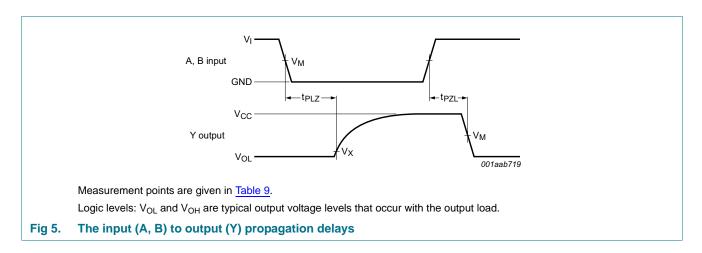
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

12. Waveform and test circuit



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Table 9. Measurement points						
Supply voltage	Input	Output				
V _{cc}	V _M	V _M	V _X			
1.65 V to 1.95 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.15 V			
2.3 V to 2.7 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.15 V			
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V			
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V			
4.5 V to 5.5 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.3 V			

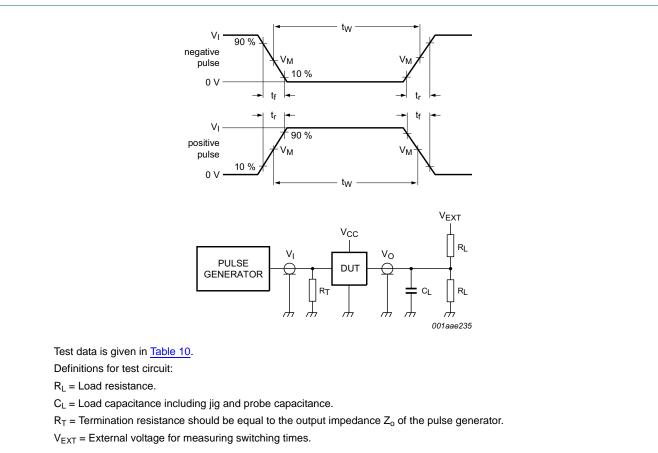


Fig 6. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input	Input Lo			V _{EXT}	
V _{cc}	VI	t _r , t _f	CL	RL	t _{PZL} , t _{PLZ}	
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	V _{CC}	
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	V _{CC}	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	V _{CC}	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	V _{CC}	
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	V _{CC}	

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13. Package outline

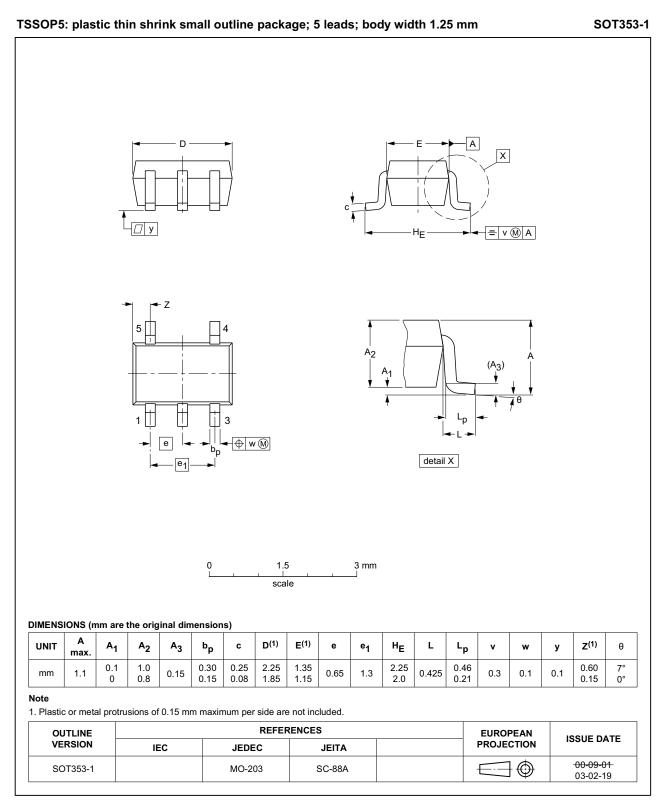


Fig 7. Package outline SOT353-1 (TSSOP5)

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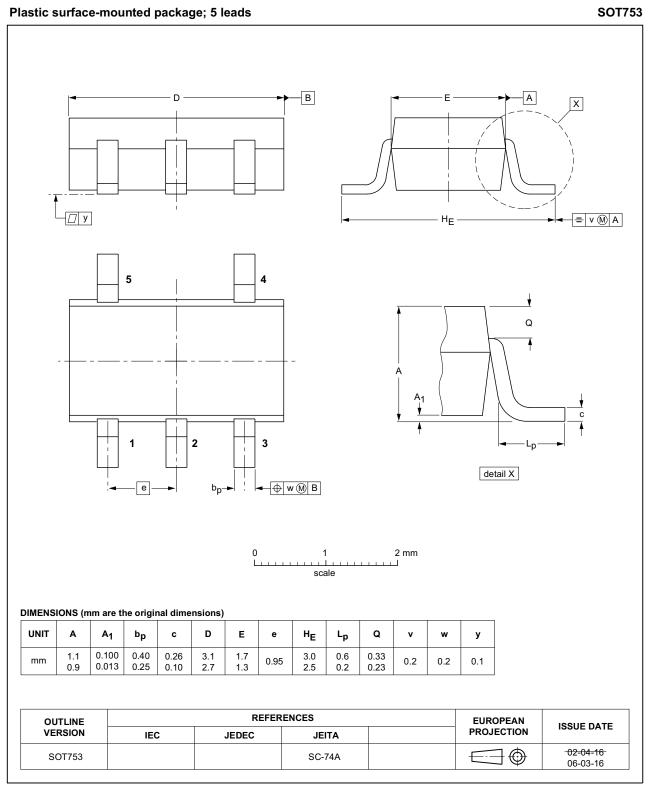


Fig 8. Package outline SOT753 (SC-74A)

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14. Abbreviations

Table 11. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MIL	Military	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

15. Revision history

Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G38_Q100 v.1	20161209	Product data sheet	-	74LVC1G38_Q100 v.1
Modifications:	• <u>Table 7</u> : The maximum limits for leakage current and supply current have changed.			
74LVC1G38_Q100 v.1	20131127	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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